



60V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) max	I _{D MAX} T _C = +25°C
60V	$6.2 \text{m}\Omega$ @ $V_{GS} = 10V$	82A
	$8.5 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{V}$	70A

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application.
- High Conversion Efficiency
- Low R_{DS(ON)}—Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- **ESD Protected Gate**
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

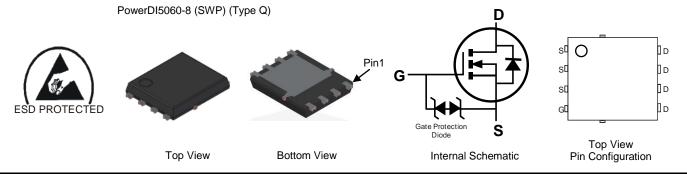
Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Synchronous Rectifier
- DC-DC Converters
- Power Management

Mechanical Data

- Case: PowerDI®5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish—Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)



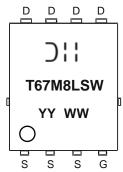
Ordering Information (Note 4)

Part Number	Case	Packaging
DMT67M8LPSW-13	PowerDI5060-8 (SWP) (Type Q)	2500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



☐ I = Manufacturer's Marking T67M8LSW = Product Type Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 19 = 2019) WW = Week Code (01 to 53)

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	V_{DSS}	60	V	
Gate-Source Voltage	V_{GSS}	±20	V	
Continuous Dunis Comment (Nata 5) V 40V	T _A = +25°C		17.3	А
Continuous Drain Current (Note 5) V _{GS} = 10V	T _A = +70°C	I _D	13.8	
Continuous Dunis Comment (Nata C) V 40V	T _C = +25°C		82	А
Continuous Drain Current (Note 6) V _{GS} = 10V	T _C = +70°C	ID	65.6	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	320	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	I _S	82	Α	
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	I _{SM}	320	Α	
Avalanche Current, L = 0.3mH		I _{AS}	23.7	Α
Avalanche Energy, L = 0.3mH		E _{AS}	84.5	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25$ °C	P_{D}	2.8	W
Thermal Resistance, Junction to Ambient (Note 5)		$R_{\theta JA}$	45	°C/W
Total Power Dissipation (Note 6)	$T_C = +25^{\circ}C$	P_{D}	62.5	W
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	2	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

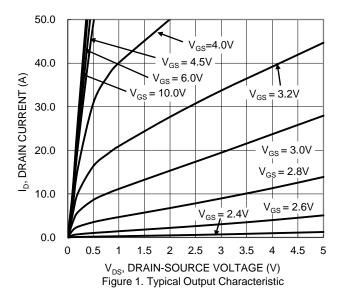
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	60		_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	1.2	1.64	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	4.4	6.2	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	6.2	8.5	11177	V _{GS} = 4.5V, I _D = 20A	
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	2130	_		$V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$	
Output Capacitance	Coss	_	786	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	70	_			
Gate Resistance	R_g	_	0.6	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	20	_		V _{DS} = 30V, I _D = 20A	
Total Gate Charge (V _{GS} = 10V)	Qq	_	37.5	_	nC		
Gate-Source Charge	Q_{gs}	_	5.4	_	IIC		
Gate-Drain Charge	Q_{qd}	_	9.5	_			
Turn-On Delay Time	t _{D(ON)}	_	5.5	_		$V_{DD} = 30V, V_{GS} = 10V,$ $I_{D} = 20A, R_{g} = 3\Omega$	
Turn-On Rise Time	t _R	_	6.8	_			
Turn-Off Delay Time	t _{D(OFF)}	_	22.1	_	ns		
Turn-Off Fall Time	t _F	_	10.8	_			
Reverse Recovery Time	t _{RR}	_	26.9	_	ns	000 11/44 0000 1/45	
Reverse Recovery Charge	Q_{RR}	_	56.8	_	nC	$I_F = 20A$, di/dt = 300A/ μ s	

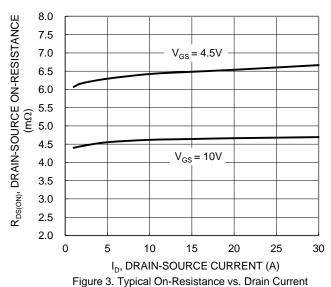
Notes:

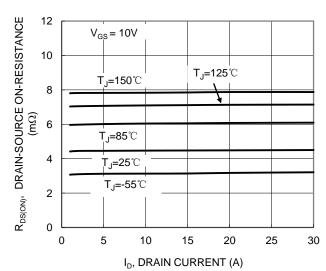
- 5. Device mounted on FR-4 substrate PCB, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 6. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





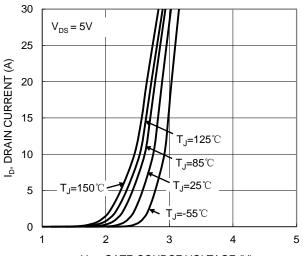






and Gate Voltage

Figure 5. Typical On-Resistance vs. Drain Current and Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2. Typical Transfer Characteristic

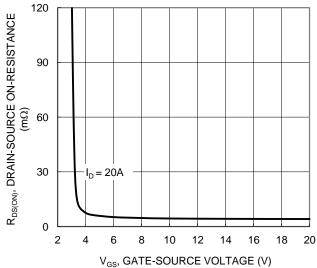


Figure 4. Typical Transfer Characteristic

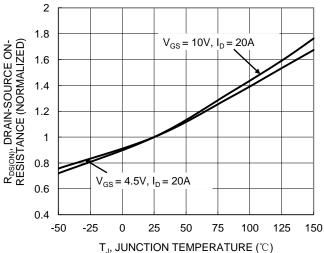


Figure 6. On-Resistance Variation with Temperature





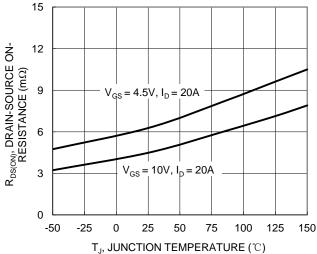


Figure 7. On-Resistance Variation with Temperature

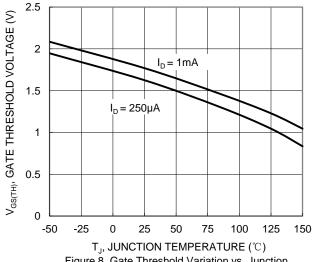


Figure 8. Gate Threshold Variation vs. Junction Temperature

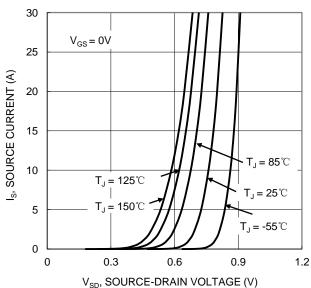
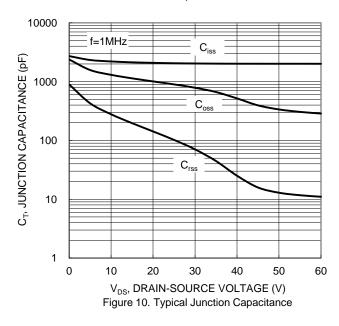
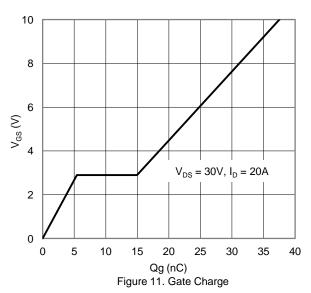


Figure 9. Diode Forward Voltage vs. Current





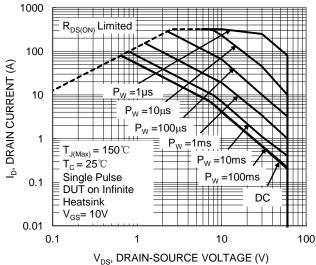


Figure 12. SOA, Safe Operation Area



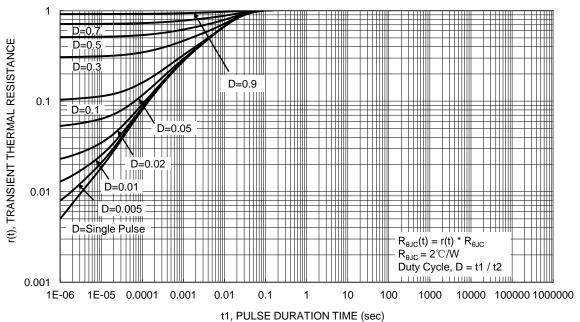


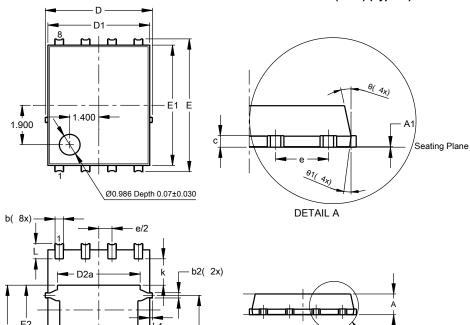
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type Q)



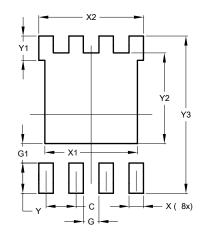
PowerDI5060-8 (SWP)						
(Type Q)						
Dim	Min	Тур				
Α	0.90	1.10	1.00			
A1	0	0.05	-			
b	0.30	0.50	0.41			
b2	0.20	0.35	0.25			
b4	().25REF				
С	0.230	0.330	0.277			
D		.15 BS0)			
D1	4.70	5.10	4.90			
D2	3.56	3.96	3.76			
D2a	3.78 4.18		3.98			
Е	6	.40 BS0	2			
E1	5.60	6.00	5.80			
E2	3.46	3.86	3.66			
E2a	4.195	4.595	4.395			
е	1.27BSC					
k	1.05					
L	0.635	0.835	0.735			
La	0.635	0.835	0.735			
L1	0.200	0.400	0.300			
L1a	0.050REF					
L4	0.025	0.225	0.125			
М	3.205	4.005	3.605 11°			
θ	10°	10° 12°				
θ1	6°	8°	7°			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8 (SWP) (Type Q)

DETAIL A



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	4.100		
X2	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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